My Account Customer Support

Home > Products > By Type > Socket/Card Products - > Product Feature Selector - > Product Details

1-1825094 -7 Product Details



1-1825094

Active

DIP Sockets

Always EU RoHS/ELV Compliant (Statement of Compliance

Product Highlights:

- **DIP Socket**
- Number of Positions = 24
- Row-to-Row Spacing = 7.87 mm
- Thru Hole
- ? Mount Style = Vertical

View all Features | Find Similar Products

Live Product Chat US (

Quick Links

Check Pricing & Availability Search for Tooling Product Feature Selector Contact Us About This Product

Documentation & Additional Information

Product Drawings:

? None Available

Catalog Pages/Data Sheets:

? None Available

Product Specifications:

? None Available

Application Specifications:

2 DIPLOMATE DL (Dual Leaf) DIP Sockets (PDF, English)

Instruction Sheets:

? None Available

CAD Files:

? None Available

Additional Information:

? Product Line Information

Related Products:

? Tooling

Product Features (Please use the Product Drawing for all design activity)

Product Type Features:

- Product Type = DIP Socket
- ? Number of Positions = 24
- ? Profile = Standard
- ? Frame Style = Ladder
- 2 Leg Style = Straight
- ? Proprietary Name = DIPLOMATE DL
- ? Color = Black
- ? Comment = ONLY sockets with straight solder tails are recommended for automatic insertion.

Electrical Characteristics:

- ? Insulation Resistance (M?) = 10,000
- ? Contact Resistance (m?) = 30

Termination Related Features:

- ? Termination (Solder) Post Length (mm [in]) 3.25 [0.128]
- ? Solder Tail Contact Plating = Tin

Body Related Features:

- Row-to-Row Spacing (mm [in]) = 7.87 [0.310]
- ? Mount Style = Vertical
- ? Centerline (mm [in]) = 2.54 [0.100]

Contact Related Features:

- ? Contact Mount = Thru Hole
- ? Contact Material = Beryllium Copper
- ? Contact Mating Area Plating Material
- ? Contact Style = Stamped + Formed
- Mating Contact Type = Dual Leaf

Housing Related Features:

List all Documents

- Housing Material = Thermoplastic Glass Reinforced
- ? Housing Flammability Rating = UL 94V -0

Configuration Related Features:

Height Above PC Board (mm [in]) [0.210]

Industry Standards:

- ? RoHS/ELV Compliance = RoHS compliant, ELV compliant
- ? <u>Lead Free Solder Processes</u> = Wave solder capable to 240°C, Wave solder capable to 260° C, Wave solder capable to 265°C
- RoHS/ELV Compliance History = Always was RoHS compliant

Conditions for Usage:

? Temperature Range (°C) = 125

Operation/Application:

Application = Production

Packaging Related Features:

Packaging Method = Tube

Prand = Tyco Electronics